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**Fine ceramics (advanced ceramics,  
advanced technical ceramics) —  
Method for measuring the power  
generation characteristics of  
piezoelectric resonant devices for  
stand-alone power sources**

iTeh STANDARD PREVIEW

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*Céramiques techniques — Méthode de mesure des caractéristiques  
de production d'énergie électrique d'un dispositif résonnant  
piézoélectrique pour une source d'alimentation autonome*

ISO 5712:2022

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## Foreword

ISO (the International Organization for Standardization) is a worldwide federation of national standards bodies (ISO member bodies). The work of preparing International Standards is normally carried out through ISO technical committees. Each member body interested in a subject for which a technical committee has been established has the right to be represented on that committee. International organizations, governmental and non-governmental, in liaison with ISO, also take part in the work. ISO collaborates closely with the International Electrotechnical Commission (IEC) on all matters of electrotechnical standardization.

The procedures used to develop this document and those intended for its further maintenance are described in the ISO/IEC Directives, Part 1. In particular, the different approval criteria needed for the different types of ISO documents should be noted. This document was drafted in accordance with the editorial rules of the ISO/IEC Directives, Part 2 (see [www.iso.org/directives](http://www.iso.org/directives)).

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For an explanation of the voluntary nature of standards, the meaning of ISO specific terms and expressions related to conformity assessment, as well as information about ISO's adherence to the World Trade Organization (WTO) principles in the Technical Barriers to Trade (TBT), see [www.iso.org/iso/foreword.html](http://www.iso.org/iso/foreword.html).

This document was prepared by Technical Committee ISO/TC 206, *Fine ceramics*.

Any feedback or questions on this document should be directed to the user's national standards body. A complete listing of these bodies can be found at [www.iso.org/members.html](http://www.iso.org/members.html).

## Introduction

Economic development is supported by infrastructure such as roads and railroads; however, maintaining ageing infrastructure at a low cost is a problem. An effective monitoring system for maintaining the health of infrastructure at a low cost is necessary, therefore a stand-alone power source is required because of requirements such as installation location, number of items and period of use. In addition, in the internet of things (IoT), power is needed everywhere in order for everything to be connected to the internet, and from that perspective a stand-alone power source is expected.

A self-supporting power source is a technology that collects energy such as light, vibration and heat, converts it into electrical energy and uses it. Power supplies for small electronic devices include those for various mobile devices, lighting switches, automotive tire-pressure monitoring systems (TPMS) and wireless sensor networks (sensor power supplies) that monitor infrastructure and the environment. The use of such power supplies is expanding to active type tags used for recognition, such as radio frequency identifiers (RFIDs). Vibratory electrical conversion using vibrational energy is considered to be easy to use because of its high energy density after sunlight. Various power generation experiments have already been conducted and its practical application has been accelerated. There are methods that use piezoelectric devices and electromagnetic induction for vibration electric conversion, but methods using ceramic piezoelectric devices are prominent because of the output voltage, device size and degree of structural freedom. The vibrations used in power generation in daily life have a wide variety of frequencies, and it is difficult to set conditions for obtaining an appropriate amount of power generation with piezoelectric devices that are highly frequency-dependent. Piezoelectric device structures are also broadly divided into cantilever (beam), plate and double-supported beam shapes, and the sizes are diversified according to the purpose and application. It is also difficult to set conditions.

Currently, the measurement of power generation performance of piezoelectric devices for self-supporting power supplies is performed by an arbitrary method. What device structure (e.g. size, structure) will be used? What kind of vibration (e.g. frequency, additional mass, displacement) is applied to the piezoelectric body? What kind of circuit configuration (e.g. output voltage, current, conversion efficiency, measuring instrument) is standardized?

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For this reason, this document was created for measuring the power generation characteristics of piezoelectric devices for self-supporting power supplies.



# Fine ceramics (advanced ceramics, advanced technical ceramics) — Method for measuring the power generation characteristics of piezoelectric resonant devices for stand-alone power sources

## 1 Scope

This document specifies a method for measuring power generation characteristics to evaluate and determine the output power, mechanical quality factor, electromechanical coupling factor and output efficiency of piezoelectric resonant devices used for self-sustaining power sources.

This document defines vibration-based test methods and characteristic parameters in order to accurately and practically evaluate the performance of piezoelectric resonant devices.

## 2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

ISO 20507, *Fine ceramics (advanced ceramics, advanced technical ceramics) — Vocabulary*

## 3 Terms and definitions

For the purposes of this document, the terms and definitions given in ISO 20507 and the following apply.

ISO and IEC maintain terminology databases for use in standardization at the following addresses:

- ISO Online browsing platform: available at <https://www.iso.org/obp>
- IEC Electropedia: available at <https://www.electropedia.org/>

### 3.1

#### **resonance frequency**

frequency when output voltage reaches maximum

### 3.2

#### **resonance peak width**

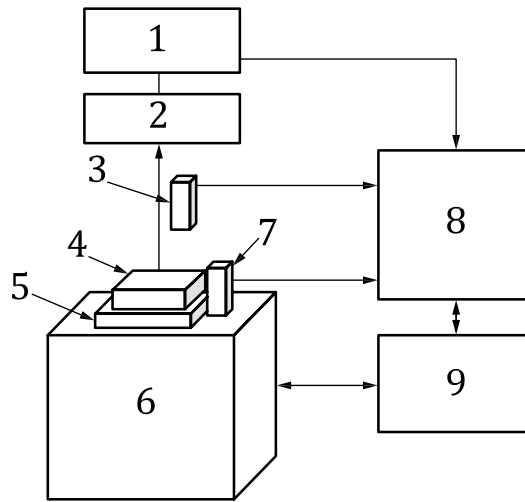
difference in frequency between two points having a value of  $1/\sqrt{2}$  of the maximum output voltage in an output voltage wave form

## 4 Measurement principle

A piezoelectric resonant device is subjected to mechanical vibration and the accompanying electrical charge generated by the piezoelectric resonant device is measured by load resistance as an output voltage, from which power generation characteristics are determined. The principal factors affecting power generation characteristics are the mechanical quality factor ( $Q_m$ ) and the electromechanical coupling coefficient ( $k^2$ ) of the piezoelectric device.

## 5 Apparatus

The equipment used for measurement and its configuration is as follows. [Figure 1](#) shows a block diagram of the measuring system. Calibrated apparatus shall be used for measurement.



### Key

1	voltmeter	6	vibration device
2	load resistance	7	accelerometer
3	laser displacement meter	8	recorder
4	piezoelectric resonant device	9	vibration controller
5	mounting jig		

**Figure 1 — Block diagram of measuring system**

**5.1 Voltmeter**, connected to the load resistance to measure the output voltage of the piezoelectric resonant device. The input impedance of the voltmeter shall be at least ten times greater than the output impedance of the piezoelectric resonant device. If the input impedance is too low, the impedance should be converted at a stage prior to the voltmeter.

**5.2 Load resistance**, a resistance between the piezoelectric resonant device and the voltmeter used for measuring the output voltage of the piezoelectric resonant device.

**5.3 Laser displacement meter**, for measuring the displacement of an object using laser light. When an additional weight can be observed directly, a laser displacement meter is used to measure change in the position of the additional weight, which improves precision in the measurement of acceleration resulting from application of mechanical vibration. On this basis, installation of a laser displacement meter is acceptable. The frequency bandwidth shall be capable of handling the applied frequency of vibration.

**5.4 Mounting jig**, for mounting a piezoelectric resonant device to the vibration device. The mounting jig shall have no natural frequency in the measurement bandwidth. The natural frequency of the mounting jig shall be higher than the upper limit of the measurement frequency. The moment of the piezoelectric resonant device attributable to resonance shall be absorbable. See [Clause A.3](#) for further information regarding the mounting jig.

**5.5 Vibration device**, which generates a mechanical vibration applied to the piezoelectric resonant device. The device shall be capable of sinusoidal output and of vibrational output at frequencies and accelerations in the ranges needed for measurement. The device should also have a feedback control function intended to prevent a decrease in applied vibrational acceleration when the piezoelectric



resonant device has reached a resonant state. The vibrating device shall be provided with anti-vibration measures. The guideline for selecting the vibration device and mounting jig is shown in [Clause A.2](#).

**5.6 Accelerometer**, which measures the acceleration of the mechanical vibration applied to the piezoelectric resonant device. Bandwidth shall be capable of handling the applied frequency of vibration. Attachment to the piezoelectric resonant device should reference [A.2.3](#).

**5.7 Recorder**, which records vibration frequency, output voltage and acceleration continually. When an additional weight can be observed directly, the displacement of the additional weight is also recorded.

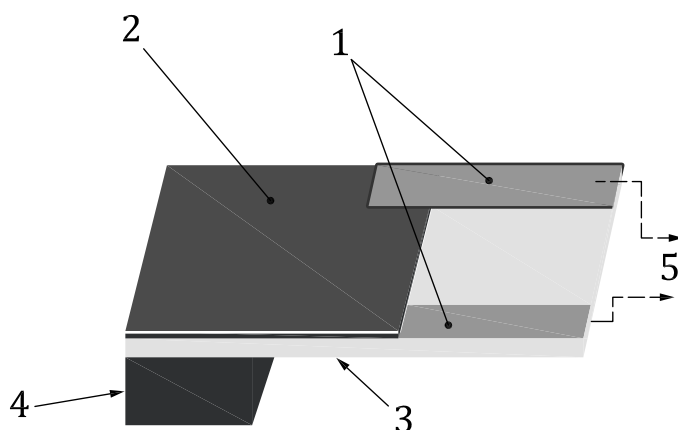
**5.8 Vibration controller**, which controls the action of the vibration resonant device to prevent noise and other such effects from changing the acceleration or frequency of applied vibration.

## 6 Piezoelectric resonant device

### 6.1 Piezoelectric resonant device configuration

The piezoelectric resonant device shall have a structure in which an additional weight is attached to the tip of a planar material to which piezoelectric material is attached. See [Figure 2](#) and [Figure 3](#).

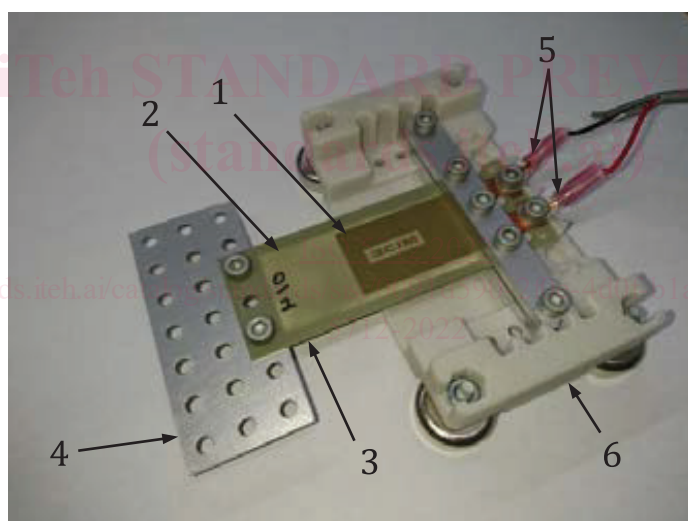
- a) The piezoelectric resonant device comprises piezoelectric material, which generates an electrical charge when subjected to a mechanical strain, planar material to which the piezoelectric material is attached and an electrode for extracting an output voltage. See [Figure 2](#) and [Figure 3](#).
- b) To obtain the output voltage efficiently, an additional weight which imparts acceleration to the piezoelectric resonant device shall be installed. The form of the additional weight is of no particular concern, provided that it does not affect vibration. The effective mass ( $m$ ) of the additional weight in [Formula \(7\)](#) used to calculate theoretical output power is taken as the sum of the mass of the applied weight and the mass of the piezoelectric material during vibration.
- c) The piezoelectric material shall be given a polarizing treatment in the orientation of its thickness.
- d) The piezoelectric resonant device shall be fixed securely to the mounting jig with bolts or other such means. See [Figure 3](#).
- e) The lead wire to extract the output voltage shall have a hardness and mass unaffected by vibrational testing.
- f) When a laser displacement meter is used, displacement of the piezoelectric resonant device should be measured as far toward its tip as possible. The surface for laser irradiation should also have a mirror finish to allow precise capture of reflected laser light.



**Key**

- |   |                        |   |                   |
|---|------------------------|---|-------------------|
| 1 | electrode              | 4 | additional weight |
| 2 | piezoelectric material | 5 | lead wire         |
| 3 | planar material        |   |                   |

**Figure 2 — Schematic of a piezoelectric resonant device**



**Key**

- |   |                        |   |                   |
|---|------------------------|---|-------------------|
| 1 | electrode              | 4 | additional weight |
| 2 | piezoelectric material | 5 | lead wire         |
| 3 | planar material        | 6 | mounting jig      |

**Figure 3 — Example of a piezoelectric resonant device fixed with a mounting jig**

**6.2 Measurement of characteristic values**

Before measuring the characteristic value, the length, width, thickness, mass and resonance frequency of the piezoelectric material forming the piezoelectric resonant device shall be measured. See [Table B.1](#). Evaluation of piezoelectric properties is based on JEITA EM-4501A<sup>[1]</sup>. If an additional weight is attached, also measure its mass.

## 7 Output voltage measurement procedure and method for creating output voltage wave form

The output voltage measurement procedure and method for creating an output voltage wave form are as follows:

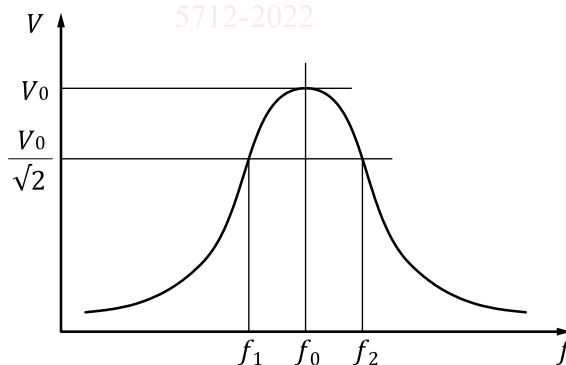
- Set an applied vibrational acceleration, mechanical vibration frequency and load resistance. Use the vibration device to apply a sinusoidal, mechanical vibration to the piezoelectric resonant device and measure the output voltage generated by load resistance at both extremes.
- Vary the frequency of the applied mechanical vibration back and forth at a constant rate between a lower-limit frequency and an upper-limit frequency set in a range of 0,9-fold to 1,1-fold centred on the resonance frequency before measurement of the piezoelectric resonant device. Keep the step width of the change in vibration frequency to 1/20 or lower versus the bandwidth of the piezoelectric resonant device. See [Table B.2](#).
- Apply the procedures in steps a) and b) with differing applied accelerations and differing mechanical vibration frequencies and load-resistance values. In a range between the minimum output of the vibration device and the rated input of the piezoelectric resonant device, vary the applied vibrational acceleration over three or more stages extending from 0,1-fold to fivefold versus the acting acceleration. In similar fashion, vary the load-resistance value over two orders of magnitude above and below a central value comprising the output impedance of the piezoelectric resonant device, and preferably over at least five stages including 0,01-fold, 0,1-fold, onefold, tenfold, a hundredfold and a thousandfold.

EXAMPLE Resonance frequency (Hz): 38 to 43 (0,1 Hz step, 1-s hold).

Applied vibrational acceleration ( $\text{m/s}^2$ ): 0,1, 0,3 and 1,0.

Load resistance ( $\text{k}\Omega$ ): 0,3, 1, 10, 30, 100, 1 000 and 10 000.

- Create an output voltage wave form using the frequencies and the output voltages of the applied mechanical vibration (see [Figure 4](#)).



### Key

$f$	frequency	$f_1$	frequency on low side when output voltage is $1/\sqrt{2}$ of maximum
$V$	output voltage	$f_2$	frequency on high side when output voltage is $1/\sqrt{2}$ of maximum
$f_0$	frequency at maximum output	$V_0$	maximum output voltage

**Figure 4 — Example of output voltage wave form**

- If the output voltage wave form is not symmetrical (see [Figure 5](#)), check the piezoelectric resonant device and its mount for any problems and check connections with other equipment or similar issues. If problems are found, perform replacement, repair, adjustment or other necessary work. See [A.2.1](#) for selection of a vibration device.